

Product Change Notification

(Notification - P1610047-DIGI)

(INNS-AC-16-0003-1)

October 10, 2016

To: *Our Valued Digi, Inc. Customer*

Overview: The purpose of this notification is to communicate a product change of select Renesas Electronics America, Inc. (REA) devices. There is no change to the part number, electrical characteristics, or product reliability.

This notification announces the addition of TSMC as an additional wafer fabrication site. Products will also continue to be produced at the current site (Renesas Naka).

Affected Products: A review of our shipment records to your company indicate the attached list of products is affected by this notification.

Booking Part Number

R5S72660W144FP#V0

R5S726B0D216FP#V0

Part numbers given in this list are for active part numbers in REA database at the time of this notification.

Key Dates:

Cross shipments from REA of products using the additional wafer fabrication site begins.

March 15th, 2017

Response: No response is required. REA will consider this notification approved 30 days after its issue. If you anticipate volumes beyond your regular rate prior to the transition date, please contact your REA sales representative with a forecast of your requirements.

Please contact you REA sales representative to obtain samples.

Please contact your REA sales representative for any questions or comments.

Thank you for your attention.

Sincerely,

Renesas Electronics America, Inc.